CM900HG-90H

HIGH POWER SWITCHING USE
INSULATED TYPE

3rd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

CM900HG-90H

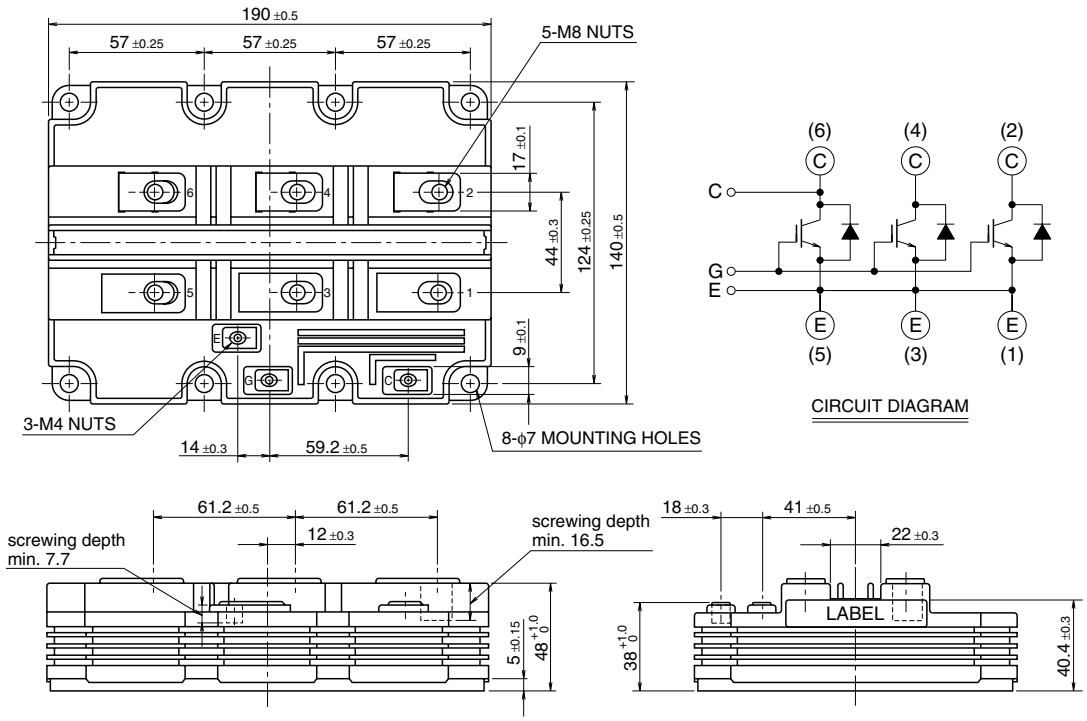
- I_C ..... 900 A
- V_{CES} ..... 4500 V
- High Insulated Type
- 1-element in a Pack
- AlSiC Baseplate

APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
V_{CES}	Collector-emitter voltage	V_{GE} = 0V, T_j = 25°C	4500	V
V_{GES}	Gate-emitter voltage	V_{CE} = 0V, T_j = 25°C	± 20	V
I_C	Collector current	DC, T_c = 100°C	900	A
I_{CM}		Pulse (Note 1)	1800	A
I_E	Emitter current (Note 2)	DC	900	A
I_{EM}		Pulse (Note 1)	1800	A
P_c	Maximum power dissipation (Note 3)	T_c = 25°C, IGBT part	11300	W
V_{iso}	Isolation voltage	RMS, sinusoidal, f = 60Hz, t = 1 min.	10200	V
V_e	Partial discharge extinction voltage	RMS, sinusoidal, f = 60Hz, Q_{PD} ≤ 10 pC	5100	V
T_j	Junction temperature		–40 ~ +150	°C
T_{op}	Operating temperature		–40 ~ +125	°C
T_{stg}	Storage temperature		–40 ~ +125	°C
t_{psc}	Maximum short circuit pulse width	V_{CC} = 3200V, V_{CE} ≤ V_{CES}, V_{GE} = 15V, T_j = 125°C	10	µs

ELECTRICAL CHARACTERISTICS

Symbol	Item	Conditions		Limits			Unit
				Min	Typ	Max	
I_{CES}	Collector cutoff current	V_{CE} = V_{CES}, V_{GE} = 0V	T_j = 25°C	—	—	5	mA
			T_j = 125°C	—	12	50	
$V_{GE(th)}$	Gate-emitter threshold voltage	V_{CE} = 10 V, I_C = 90 mA, T_j = 25°C		5.0	6.0	7.0	V
I_{GES}	Gate leakage current	V_{GE} = V_{GES}, V_{CE} = 0V, T_j = 25°C		—	—	0.5	µA
C_{ies}	Input capacitance	V_{CE} = 10 V, V_{GE} = 0 V, f = 100 kHz, T_j = 25°C		—	162	—	nF
C_{oes}	Output capacitance			—	12	—	nF
C_{res}	Reverse transfer capacitance			—	3.6	—	nF
Q_g	Total gate charge	V_{CC} = 2250 V, I_C = 900 A, V_{GE} = ±15 V, T_j = 25°C		—	15	—	µC
$V_{CE(sat)}$	Collector-emitter saturation voltage	I_C = 900 A (Note 4), V_{GE} = 15 V	T_j = 25°C	—	3.45	—	V
			T_j = 125°C	—	3.70	—	
$t_{d(on)}$	Turn-on delay time	V_{CC} = 2250 V, I_C = 900 A, V_{GE} = ±15 V, R_G = 10 Ω, T_j = 125°C, L_s = 100 nH, Inductive load		—	—	2.40	µs
t_r	Turn-on rise time			—	—	1.20	µs
$E_{on(10\%)}$	Turn-on switching energy (Note 5)			—	4.20	—	J/P
$t_{d(off)}$	Turn-off delay time	V_{CC} = 2250 V, I_C = 900 A, V_{GE} = ±15 V, R_G = 10 Ω, T_j = 125°C, L_s = 100 nH, Inductive load		—	—	6.00	µs
t_f	Turn-off fall time			—	—	1.20	µs
$E_{off(10\%)}$	Turn-off switching energy (Note 5)			—	2.50	—	J/P
V_{EC}	Emitter-collector voltage (Note 2)	I_E = 900 A (Note 4), V_{GE} = 0 V	T_j = 25°C	—	4.80	—	V
			T_j = 125°C	—	4.15	—	
t_{rr}	Reverse recovery time (Note 2)	V_{CC} = 2250 V, I_E = 900 A, V_{GE} = ±15 V, R_G = 10 Ω, T_j = 125°C, L_s = 100 nH, Inductive load		—	—	1.80	µs
Q_{rr}	Reverse recovery charge (Note 2)			—	920	—	µC
$E_{rec(10\%)}$	Reverse recovery energy (Note 2), (Note 5)			—	1.00	—	J/P

THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
$R_{th(j-c)Q}$	Thermal resistance	Junction to Case, IGBT part	—	—	11.0	K/kW
$R_{th(j-c)R}$	Thermal resistance	Junction to Case, FWDi part	—	—	22.0	K/kW
$R_{th(c-f)}$	Contact thermal resistance	Case to Fin, λ_{grease} = 1W/m·K, D(c-f) = 100 μm	—	6.0	—	K/kW

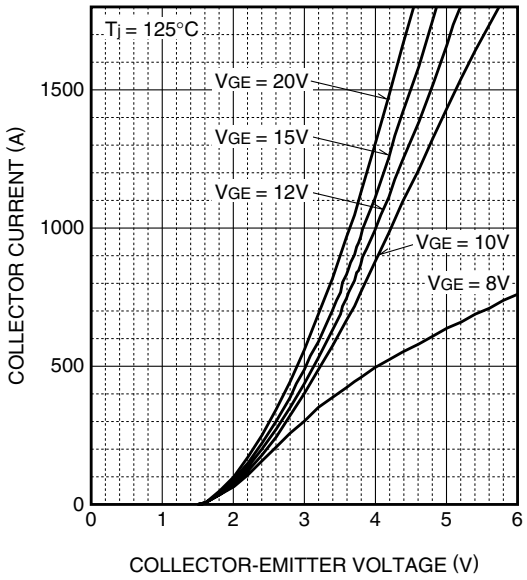
MECHANICAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
M_t	Mounting torque	M8: Main terminals screw	7.0	—	15.0	N·m
M_s		M6: Mounting screw	3.0	—	6.0	N·m
M_t		M4: Auxiliary terminals screw	1.0	—	3.0	N·m
m	Mass		—	1.35	—	kg
CTI	Comparative tracking index		600	—	—	—
d_a	Clearance		26	—	—	mm
d_s	Creepage distance		56	—	—	mm
$L_{P\ CE}$	Internal inductance		—	17	—	nH
$R_{CC'+EE'}$	Internal lead resistance	T_c = 25°C	—	0.14	—	mΩ

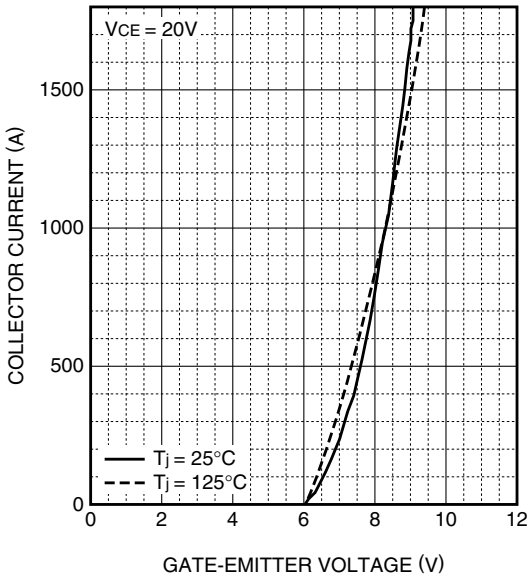
Note 1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{opmax} rating (125°C).
2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).
3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).
4. Pulse width and repetition rate should be such as to cause negligible temperature rise.
5. $E_{on(10\%)}$ / $E_{off(10\%)}$ / $E_{rec(10\%)}$ are the integral of $0.1V_{CE} \times 0.1I_C\ dt$.

PERFORMANCE CURVES

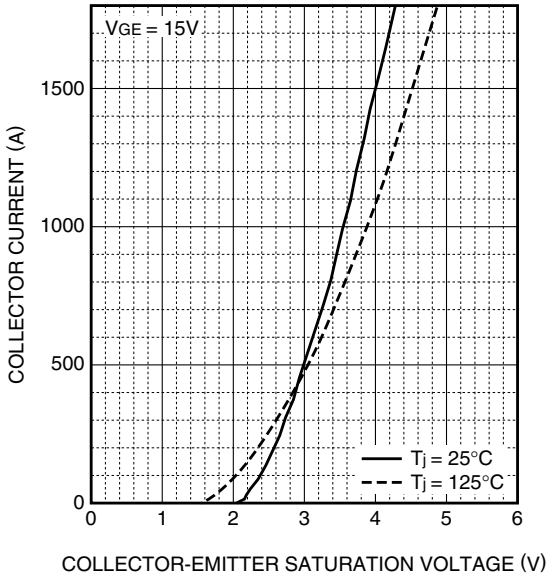
OUTPUT CHARACTERISTICS (TYPICAL)



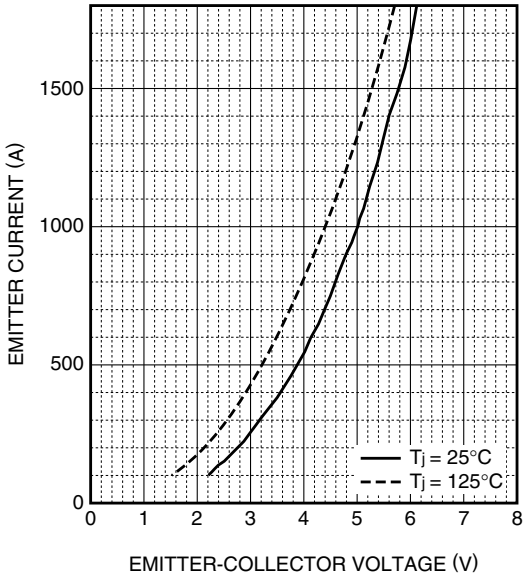
TRANSFER CHARACTERISTICS (TYPICAL)



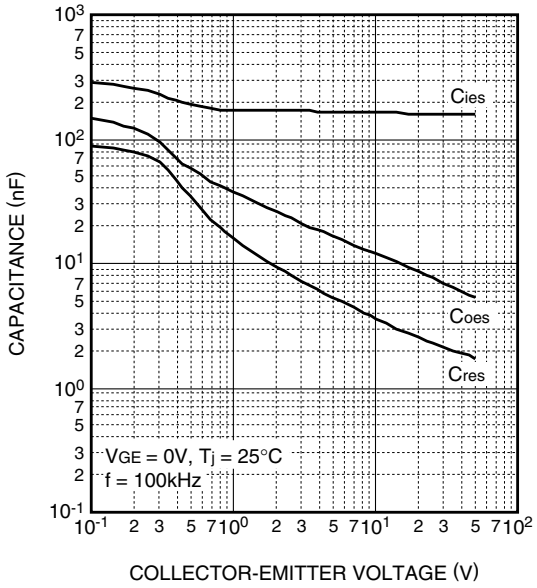
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



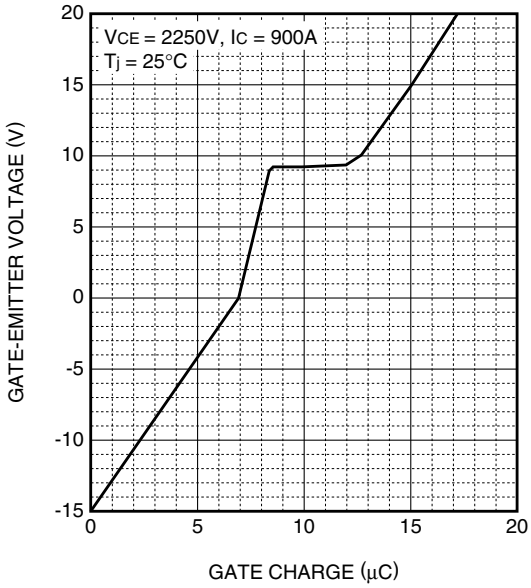
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



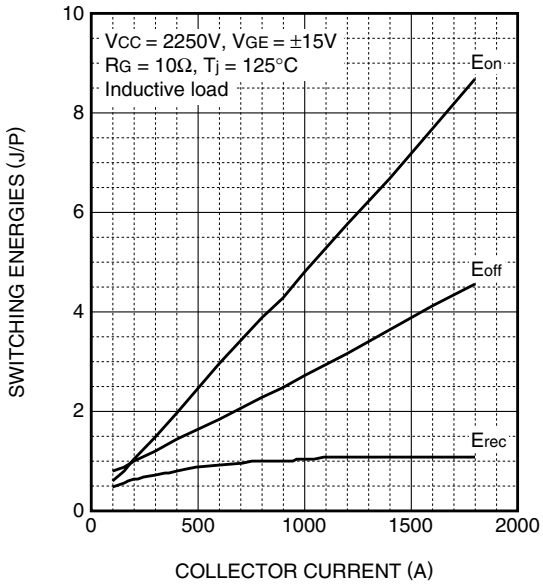
CAPACITANCE CHARACTERISTICS (TYPICAL)



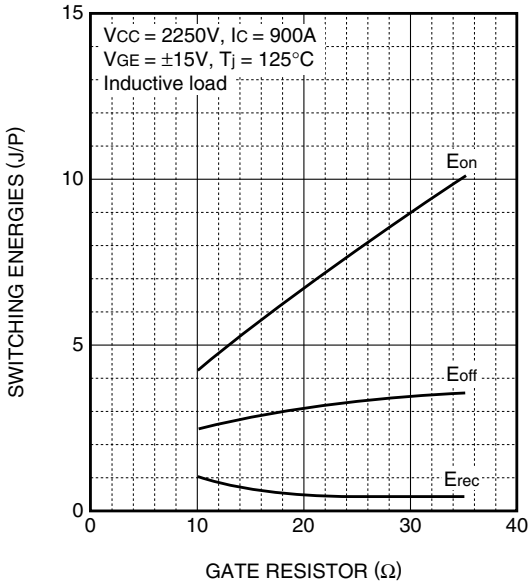
GATE CHARGE CHARACTERISTICS (TYPICAL)



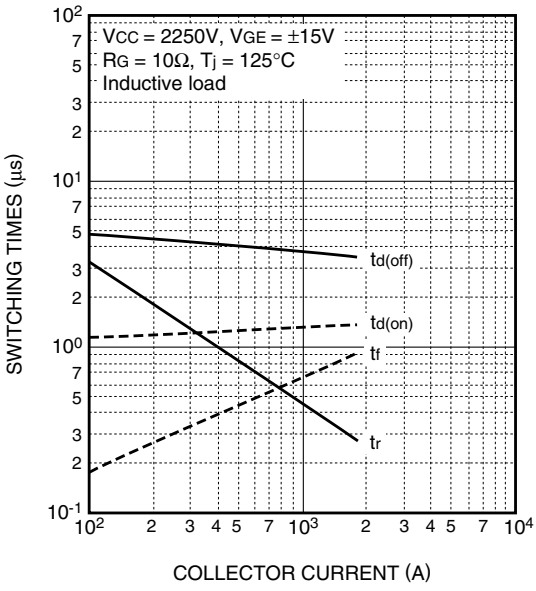
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



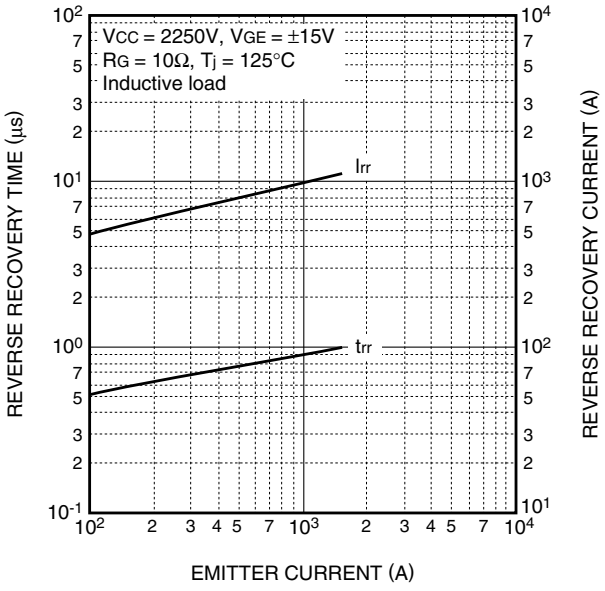
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



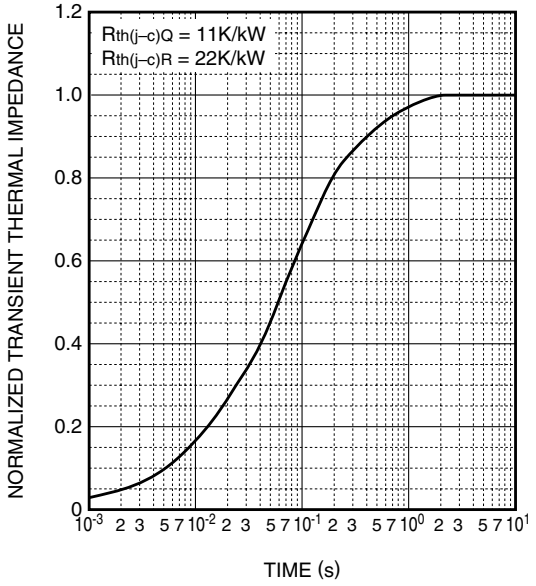
HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



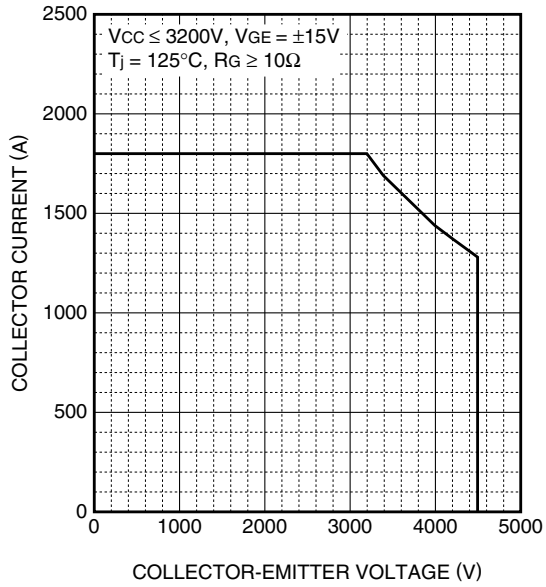
TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



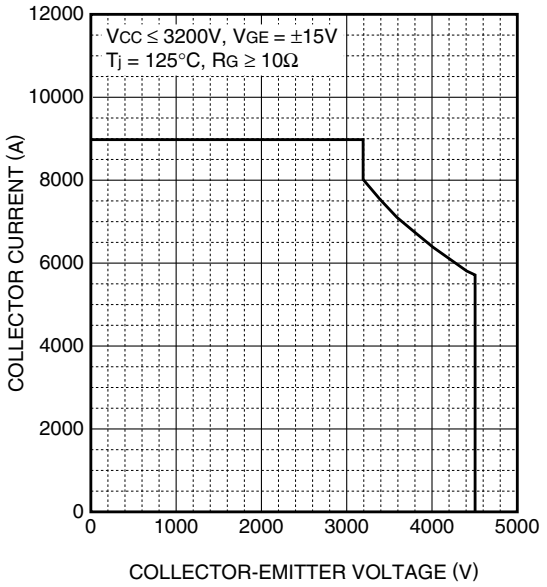
$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_i \left\{ 1 - exp\left(-\frac{t}{\tau_i}\right) \right\}$$

	1	2	3	4
R_i [K/kW]	0.0059	0.0978	0.6571	0.2392
τ_i [sec]	0.0002	0.0074	0.0732	0.4488

REVERSE BIAS SAFE OPERATING AREA (RBSOA)



SHORT CIRCUIT SAFE OPERATING AREA (SCSOA)



FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)